

# PATENT ASSIGNMENT

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<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
CHIEN-HUNG LEE	07/27/2011
SHIH-CHI WONG	07/27/2011
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	HON HAI PRECISION INDUSTRY CO., LTD.
<b>Street Address:</b>	66,CHUNG SHAN ROAD
<b>City:</b>	Tu-Cheng, New Taipei
<b>State/Country:</b>	TAIWAN
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	13197790
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	(909)978-6366
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>	
<b>Phone:</b>	9099786584
<b>Email:</b>	Raymond.Chew@foxconn.com
<b>Correspondent Name:</b>	Raymond J. Chew
<b>Address Line 1:</b>	288 South Mayo Avenue
<b>Address Line 4:</b>	City of Industry, CALIFORNIA 91789
<b>ATTORNEY DOCKET NUMBER:</b>	US39104
<b>NAME OF SUBMITTER:</b>	Raymond J. Chew
<b>Total Attachments: 2</b> source=US39104110801ASM#page1.tif source=US39104110801ASM#page2.tif	

CH \$40.00 13197790

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**PATENT**  
**REEL: 026697 FRAME: 0838**

## ASSIGNMENT

In consideration of value received, the receipt and sufficiency of which are hereby acknowledged, the undersigned ASSIGNOR(S)

1.	<u>CHIEN-HUNG LEE</u>	, residing at	<u>Tu-Cheng, New Taipei, Taiwan</u>
2.	<u>SHIH-CHI WONG</u>	, residing at	<u>Tu-Cheng, New Taipei, Taiwan</u>
3.	<u></u>	, residing at	<u></u>
4.	<u></u>	, residing at	<u></u>
5.	<u></u>	, residing at	<u></u>
6.	<u></u>	, residing at	<u></u>
7.	<u></u>	, residing at	<u></u>
8.	<u></u>	, residing at	<u></u>

hereby sell(s), assign(s) and transfer(s) unto: **HON HAI PRECISION INDUSTRY CO., LTD.** having a principal place of business at **66, Chung Shan Road, Tu-Cheng Dist., New Taipei City, Taiwan, R.O.C.** hereafter designated "ASSIGNEE" the entire right, title and interest for the United States of America as defined in 35 U.S.C. 100, in the invention and all patent applications including any and all divisions, continuations, substitutes, and reissues thereof, and all resulting patents, known as **CHARGING ASSEMBLY FOR ELECTRONIC DEVICE** for which the undersigned

[ ] previously executed --- Ser. No. \_\_\_\_\_ and filing date of \_\_\_\_\_  
 [ x ] is executing concurrently herewith

an application for Letters Patent of United States of America

AND the undersigned hereby authorize(s) and request(s) the United States Commissioner of Patents and Trademarks to issue said Letters Patent to the said ASSIGNEE, for its interest as ASSIGNEE, its successors, assigns and legal representatives; the undersigned agree(s) that the attorneys of record in said application, if any, shall hereafter act on behalf of said ASSIGNEE;

AND the undersigned hereby agree(s) to testify and execute any papers for ASSIGNEE, its successors, assigns and legal representatives, deemed essential by ASSIGNEE to ASSIGNEE's full protection and title in and to the invention hereby transferred.

1.	<u>Chien-Hung Lee</u> CHIEN-HUNG LEE	<u>Jul.27,2011</u> Date
2.	<u>Shih-Chi Wong</u> SHIH-CHI WONG	<u>Jul.27,2011</u> Date
3.	_____	_____ Date
4.	_____	_____ Date
5.	_____	_____ Date
6.	_____	_____ Date
7.	_____	_____ Date
8.	_____	_____ Date
9.	_____	_____ Date